CMOS Digital Integrated Circuits Silicon Monolithic

# 7UL1G07FU

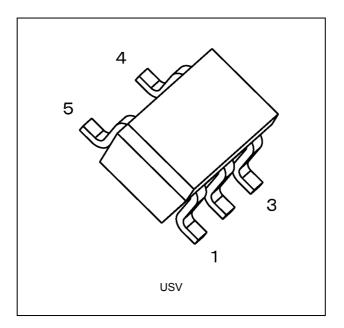
### 1. Functional Description

• Non-Inverter (Open Drain)

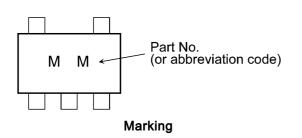
#### 2. Features

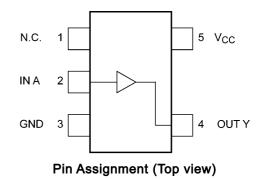
- (1) Wide operating temperature range:  $T_{opr} = -40$  to 125 °C
- (2) High output current: 8.0 mA (min) at  $V_{CC}$  = 3.0 V
- (3) Super high speed operation:  $t_{pd}$  = 2.5 ns (typ.) at V<sub>CC</sub> = 3.3 V, C<sub>L</sub> = 15 pF
- (4) Operating voltage range:  $V_{CC} = 0.9$  to 3.6 V
- (5) 3.6 V tolerant input
- (6) 3.6 V power down protection output

#### 3. Packaging



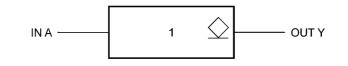
4. Marking and Pin Assignment





Start of commercial production 2020-03

### 5. IEC Logic Symbol



#### 6. Truth Table

Input A	Input Y
L	L
Н	Z

Z: High impedance

### 7. Absolute Maximum Ratings (Note) (Unless otherwise specified, $T_a = 25$ °C)

Characteristics	Symbol	Note	Rating	Unit
Supply voltage	V <sub>CC</sub>		-0.5 to 4.6	V
Input voltage	V <sub>IN</sub>		-0.5 to 4.6	V
DC output voltage	V <sub>OUT</sub>	(Note 1)	-0.5 to 4.6	V
Input diode current	I <sub>IK</sub>		-20	mA
Output diode current	I <sub>ОК</sub>	(Note 2)	-20	mA
DC output current	I <sub>OUT</sub>		25	mA
V <sub>CC</sub> /ground current	I <sub>CC</sub>		±50	mA
Power dissipation	PD		200	mW
Storage temperature	T <sub>stg</sub>		-65 to 150	°C

Note: Exceeding any of the absolute maximum ratings, even briefly, lead to deterioration in IC performance or even destruction.

Using continuously under heavy loads (e.g. the application of high temperature/current/voltage and the significant change in temperature, etc.) may cause this product to decrease in the reliability significantly even if the operating conditions (i.e. operating temperature/current/voltage, etc.) are within the absolute maximum ratings and the operating ranges.

Please design the appropriate reliability upon reviewing the Toshiba Semiconductor Reliability Handbook ("Handling Precautions"/"Derating Concept and Methods") and individual reliability data (i.e. reliability test report and estimated failure rate, etc).

Note 1: When  $V_{CC}$  = 0 V or when the output is in the high-impedance state Note 2:  $V_{OUT}$  < GND

### 8. Operating Ranges (Note)

Characteristics	Symbol	Test Condition	Rating	Unit
Supply voltage	V <sub>CC</sub>		0.9 to 3.6	V
Input voltage	V <sub>IN</sub>	_	0 to 3.6	V
Output voltage	V <sub>OUT</sub>	_	0 to 3.6	V
Output current	I <sub>OH</sub> ,I <sub>OL</sub>	V <sub>CC</sub> = 3.0 to 3.6 V	8.0	mA
		V <sub>CC</sub> = 2.3 to 2.7 V	4.0	1
		V <sub>CC</sub> = 1.65 to 1.95 V	3.0	1
		V <sub>CC</sub> = 1.4 to 1.6 V	1.7	1
		V <sub>CC</sub> = 1.1 to 1.3 V	0.3	1
		V <sub>CC</sub> = 0.9 V	0.02	1
Operating temperature	T <sub>opr</sub>		-40 to 125	°C
Input rise and fall time	dt/dv	$V_{IN}$ = 0.8 to 2.0 V, $V_{CC}$ = 3.0 V	0 to 10	ns/V

Note: The operating ranges must be maintained to ensure the normal operation of the device. Unused inputs must be tied to either  $V_{CC}$  or GND.

### 9. Electrical Characteristics

### 9.1. DC Characteristics (Unless otherwise specified, T<sub>a</sub> = 25 °C)

Characteristics	Symbol	Test Condition	ı	V <sub>CC</sub> (V)	Min	Тур.	Max	Unit
High-level input voltage	V <sub>IH</sub>	—		0.9	V <sub>CC</sub>	_	_	V
				1.1 to 1.3	$V_{CC}  imes 0.70$	_	_	
				1.4 to 1.6	$V_{CC}  imes 0.65$	_	_	
				1.65 to 1.95	$V_{CC}  imes 0.65$	_	_	
				2.3 to 2.7	1.7	_	_	
				3.0 to 3.6	2.0	_	_	
Low-level input voltage	VIL	—		0.9	_	_	GND	V
				1.1 to 1.3	_	_	$V_{CC} \times 0.30$	
				1.4 to 1.6	—	_	$V_{CC} \times 0.35$	
				1.65 to 1.95	—	_	$V_{CC}  imes 0.35$	
				2.3 to 2.7	_	_	0.7	
				3.0 to 3.6	_	_	0.8	
Low-level output voltage	V <sub>OL</sub>	$V_{IN} = V_{IL}$	I <sub>OL</sub> = 0.02 mA	0.9	—	_	0.1	V
			I <sub>OL</sub> = 0.3 mA	1.1 to 1.3	—	—	$V_{CC} \times 0.25$	
			I <sub>OL</sub> = 1.7 mA	1.4 to 1.6	—	_	$V_{CC} \times 0.25$	
			I <sub>OL</sub> = 3.0 mA	1.65 to 1.95	—	_	0.45	
			I <sub>OL</sub> = 4.0 mA	2.3 to 2.7	—	_	0.4	
			I <sub>OL</sub> = 8.0 mA	3.0 to 3.6	—	_	0.4	
Input leakage current	I <sub>IN</sub>	V <sub>IN</sub> = 0 to 3.6 V		0 to 3.6	—	_	±0.1	μA
3-state output OFF-state leakage current	I <sub>OZ</sub>	V <sub>IN</sub> = V <sub>IH</sub> , V <sub>OUT</sub> = 0 to 3.6 V		0.9 to 3.6	—		±1.0	μA
Power-OFF leakage current	I <sub>OFF</sub>	V <sub>IN</sub> = 0 to 3.6 V, V <sub>OUT</sub> = 0 to 3.6 V		0	—	—	1.0	μA
Quiescent supply current	I <sub>CC</sub>	$V_{IN} = V_{CC}$ or GND		3.6	_		1.0	μA

### 9.2. DC Characteristics (Unless otherwise specified, $T_a = -40$ to 85 °C)

Characteristics	Symbol	Test Condition	on	V <sub>CC</sub> (V)	Min	Max	Unit
High-level input voltage	V <sub>IH</sub>	_		0.9	V <sub>CC</sub>		V
				1.1 to 1.3	$V_{CC} \times 0.70$	_	
				1.4 to 1.6	$V_{CC}  imes 0.65$	—	
				1.65 to 1.95	$V_{CC}  imes 0.65$	—	
				2.3 to 2.7	1.7	—	
				3.0 to 3.6	2.0	—	
Low-level input voltage	VIL	—		0.9	—	GND	V
				1.1 to 1.3	_	$V_{CC}  imes 0.30$	
				1.4 to 1.6	_	$V_{CC}  imes 0.35$	
				1.65 to 1.95	_	$V_{CC}  imes 0.35$	
				2.3 to 2.7	_	0.7	
				3.0 to 3.6	_	0.8	
Low-level output voltage	V <sub>OL</sub>	V <sub>IN</sub> = V <sub>IL</sub>	I <sub>OL</sub> = 0.02 mA	0.9	_	0.1	V
			I <sub>OL</sub> = 0.3 mA	1.1 to 1.3	_	$V_{CC}  imes 0.25$	
			I <sub>OL</sub> = 1.7 mA	1.4 to 1.6	_	$V_{CC}  imes 0.25$	
			I <sub>OL</sub> = 3.0 mA	1.65 to 1.95	—	0.45	
			I <sub>OL</sub> = 4.0 mA	2.3 to 2.7	—	0.4	
			I <sub>OL</sub> = 8.0 mA	3.0 to 3.6	_	0.4	
Input leakage current	I <sub>IN</sub>	V <sub>IN</sub> = 0 to 3.6 V		0 to 3.6	_	±0.5	μA
3-state output OFF-state leakage current	I <sub>OZ</sub>	V <sub>IN</sub> = V <sub>IH</sub> , V <sub>OUT</sub> = 0 to 3.6 V		0.9 to 3.6	—	±10.0	μA
Power-OFF leakage current	I <sub>OFF</sub>	V <sub>IN</sub> = 0 to 3.6 V, V <sub>OUT</sub> = 0 to 3.6 V		0	—	10.0	μA
Quiescent supply current	I <sub>CC</sub>	V <sub>IN</sub> = V <sub>CC</sub> or GND		3.6	_	10.0	μA

### 9.3. DC Characteristics (Unless otherwise specified, $T_a = -40$ to 125 °C)

Characteristics	Symbol	Test Conditio	n	V <sub>CC</sub> (V)	Min	Max	Unit
High-level input voltage	V <sub>IH</sub>	_		0.9	V <sub>CC</sub>	—	V
				1.1 to 1.3	$V_{CC} \times 0.70$	—	
				1.4 to 1.6	$V_{CC}  imes 0.65$	—	
				1.65 to 1.95	$V_{CC}  imes 0.65$	—	
				2.3 to 2.7	1.7	—	
				3.0 to 3.6	2.0	_	
Low-level input voltage	V <sub>IL</sub>	—		0.9	—	GND	V
				1.1 to 1.3	—	$V_{CC} \times 0.30$	
				1.4 to 1.6	—	$V_{CC} \times 0.35$	
				1.65 to 1.95	—	$V_{CC} \times 0.35$	
				2.3 to 2.7	—	0.7	
				3.0 to 3.6	_	0.8	
Low-level output voltage	V <sub>OL</sub>	$V_{IN} = V_{IL}$	I <sub>OL</sub> = 0.02 mA	0.9	—	0.1	V
			I <sub>OL</sub> = 0.3 mA	1.1 to 1.3	—	$V_{CC} \times 0.27$	
			I <sub>OL</sub> = 1.7 mA	1.4 to 1.6	—	$V_{CC} \times 0.27$	
			I <sub>OL</sub> = 3.0 mA	1.65 to 1.95	—	0.5	
			I <sub>OL</sub> = 4.0 mA	2.3 to 2.7	—	0.45	
			I <sub>OL</sub> = 8.0 mA	3.0 to 3.6	—	0.45	
Input leakage current	I <sub>IN</sub>	V <sub>IN</sub> = 0 to 3.6 V	•	0 to 3.6	_	±2.0	μA
3-state output OFF-state leakage current	I <sub>OZ</sub>	V <sub>IN</sub> = V <sub>IH</sub> V <sub>OUT</sub> = 0 to 3.6 V		0.9 to 3.6	_	±80.0	μA
Power-OFF leakage current	I <sub>OFF</sub>	V <sub>IN</sub> = 0 to 3.6 V V <sub>OUT</sub> = 0 to 3.6 V		0	—	80.0	μA
Quiescent supply current	I <sub>CC</sub>	V <sub>IN</sub> = V <sub>CC</sub> or GND		3.6	—	80.0	μA

### 9.4. AC Characteristics (Unless otherwise specified, $T_a = 25$ °C, Input: $t_r = t_f = 3$ ns)

Characteristics	Symbol	Note	Test Condition	V <sub>CC</sub> (V)	C <sub>L</sub> (pF)	Min	Тур.	Max	Unit
Output enable time	t <sub>PZL</sub>		R <sub>L</sub> = 100 kΩ See Fig. 9.7.1, 9.8.2, Table 9.8.1	0.9	10	—	23.0	—	ns
			$R_L = 5 k\Omega$	1.1 to 1.3			10.8	18.7	
			See Fig. 9.7.1, 9.8.2, Table 9.8.1	1.4 to 1.6		_	6.2	9.5	
				1.65 to 1.95		_	4.5	7.0	
				2.3 to 2.7			3.1	4.6	
				3.0 to 3.6		_	2.5	3.6	
			R <sub>L</sub> = 100 kΩ See Fig. 9.7.1, 9.8.2, Table 9.8.1	0.9	15	—	25.2	—	ns
			R <sub>L</sub> = 5 kΩ	1.1 to 1.3		_	11.8	20.7	
			See Fig. 9.7.1, 9.8.2, Table 9.8.1	1.4 to 1.6		_	6.9	10.0	
				1.65 to 1.95			5.1	7.3	
				2.3 to 2.7		_	3.4	4.8	1
				3.0 to 3.6		_	2.8	3.7	
			R <sub>L</sub> = 100 kΩ See Fig. 9.7.1, 9.8.2, Table 9.8.1	0.9	30		31.0		ns
			R <sub>L</sub> = 5 kΩ	1.1 to 1.3		_	15.7	30.7	
			See Fig. 9.7.1, 9.8.2, Table 9.8.1	1.4 to 1.6		_	8.6	13.1	
				1.65 to 1.95		_	6.6	9.2	
				2.3 to 2.7			4.5	5.8	
				3.0 to 3.6			3.7	4.5	
Output disable time	t <sub>PLZ</sub>		R <sub>L</sub> = 100 kΩ See Fig. 9.7.1, 9.8.2, Table 9.8.1	0.9	10	_	120.7	—	ns
			$R_L = 5 k\Omega$	1.1 to 1.3			10.6	16.0	
			See Fig. 9.7.1, 9.8.2, Table 9.8.1	1.4 to 1.6			6.3	9.1	
				1.65 to 1.95			7.3	8.6	
				2.3 to 2.7			5.1	6.4	1
				3.0 to 3.6		_	5.8	7.9	
			R <sub>L</sub> = 100 kΩ See Fig. 9.7.1, 9.8.2, Table 9.8.1	0.9	15	—	152.4	—	ns
			R <sub>L</sub> = 5 kΩ	1.1 to 1.3			12.2	16.9	
			See Fig. 9.7.1, 9.8.2, Table 9.8.1	1.4 to 1.6			7.5	9.8	
				1.65 to 1.95			8.3	9.6	
				2.3 to 2.7			6.0	9.4	
				3.0 to 3.6			7.1	9.5	
			R <sub>L</sub> = 100 kΩ See Fig. 9.7.1, 9.8.2, Table 9.8.1	0.9	30	—	246.9	—	ns
			R <sub>L</sub> = 5 kΩ	1.1 to 1.3		_	16.9	20.8	1
			See Fig. 9.7.1, 9.8.2, Table 9.8.1	1.4 to 1.6			10.1	13.2	1
				1.65 to 1.95		_	12.7	14.6	1
				2.3 to 2.7		_	8.6	10.8	1
				3.0 to 3.6			12.2	14.4	1
Input capacitance	C <sub>IN</sub>		—	3.6	—	_	3	_	pF
Power dissipation capacitance	C <sub>PD</sub>	(Note 1)	_	0.9 to 3.6	_		9	—	pF

Note 1: C<sub>PD</sub> is defined as the value of the internal equivalent capacitance which is calculated from the operating current consumption without load. Average operating current can be obtained by the equation.

 $I_{CC(opr)} = C_{PD} \cdot V_{CC} \cdot f_{IN} + I_{CC}$ 

## 9.5. AC Characteristics (Unless otherwise specified, $T_a = -40$ to 85 °C, Input: $t_r = t_f = 3$ ns)

Characteristics	Symbol	Test Condition	V <sub>CC</sub> (V)	C <sub>L</sub> (pF)	Min	Max	Unit
Output enable time	t <sub>PZL</sub>	R <sub>L</sub> = 100 kΩ See Fig. 9.7.1, 9.8.2, Table 9.8.1	0.9	10		_	ns
		$R_L = 5 k\Omega$	1.1 to 1.3		1.0	29.8	
		See Fig. 9.7.1, 9.8.2, Table 9.8.1	1.4 to 1.6		1.0	11.3	
			1.65 to 1.95	]	1.0	7.5	
			2.3 to 2.7		1.0	5.2	
			3.0 to 3.6		1.0	4.2	
		R <sub>L</sub> = 100 kΩ See Fig. 9.7.1, 9.8.2, Table 9.8.1	0.9	15	_	_	ns
		$R_L = 5 k\Omega$	1.1 to 1.3		1.0	34.7	
		See Fig. 9.7.1, 9.8.2, Table 9.8.1	1.4 to 1.6		1.0	11.1	
			1.65 to 1.95		1.0	8.5	
			2.3 to 2.7		1.0	5.7	
			3.0 to 3.6		1.0	4.9	
		R <sub>L</sub> = 100 kΩ See Fig. 9.7.1, 9.8.2, Table 9.8.1	0.9	30	_	_	ns
		R <sub>L</sub> = 5 kΩ	1.1 to 1.3		1.0	50.5	
		See Fig. 9.7.1, 9.8.2, Table 9.8.1	1.4 to 1.6		1.0	15.1	
			1.65 to 1.95		1.0	11.9	
			2.3 to 2.7		1.0	7.6	
			3.0 to 3.6		1.0	6.1	
Output disable time	t <sub>PLZ</sub>	$R_L$ = 100 kΩ See Fig. 9.7.1, 9.8.2, Table 9.8.1	0.9	10	_	—	ns
		R <sub>L</sub> = 5 kΩ	1.1 to 1.3		1.0	22.4	
		See Fig. 9.7.1, 9.8.2, Table 9.8.1	1.4 to 1.6	]	1.0	10.4	
			1.65 to 1.95		1.0	9.8	
			2.3 to 2.7		1.0	7.2	
			3.0 to 3.6	]	1.0	9.3	
		R <sub>L</sub> = 100 kΩ See Fig. 9.7.1, 9.8.2, Table 9.8.1	0.9	15			ns
		R <sub>L</sub> = 5 kΩ	1.1 to 1.3		1.0	25.1	
		See Fig. 9.7.1, 9.8.2, Table 9.8.1	1.4 to 1.6		1.0	11.3	
			1.65 to 1.95		1.0	11.1	
			2.3 to 2.7		1.0	12.4	
			3.0 to 3.6		1.0	13.2	
		R <sub>L</sub> = 100 kΩ See Fig. 9.7.1, 9.8.2, Table 9.8.1	0.9	30			ns
		$R_L = 5 k\Omega$	1.1 to 1.3	]	1.0	31.9	
		See Fig. 9.7.1, 9.8.2, Table 9.8.1	1.4 to 1.6		1.0	14.9	
			1.65 to 1.95	]	1.0	16.6	
			2.3 to 2.7		1.0	12.2	
			3.0 to 3.6		1.0	16.4	

## 9.6. AC Characteristics (Unless otherwise specified, $T_a = -40$ to 125 °C, Input: $t_r = t_f = 3$ ns)

Characteristics	Symbol	Test Condition	V <sub>CC</sub> (V)	C <sub>L</sub> (pF)	Min	Max	Unit
Output enable time	t <sub>PZL</sub>	R <sub>L</sub> = 100 kΩ See Fig. 9.7.1, 9.8.2, Table 9.8.1	0.9	10	_	_	ns
		$R_L = 5 k\Omega$	1.1 to 1.3		1.0	37.2	
		See Fig. 9.7.1, 9.8.2, Table 9.8.1	1.4 to 1.6		1.0	12.5	
			1.65 to 1.95		1.0	8.2	
			2.3 to 2.7		1.0	5.8	
			3.0 to 3.6		1.0	4.8	
		R <sub>L</sub> = 100 kΩ See Fig. 9.7.1, 9.8.2, Table 9.8.1	0.9	15	—	_	ns
		R <sub>L</sub> = 5 kΩ	1.1 to 1.3		1.0	44.1	
		See Fig. 9.7.1, 9.8.2, Table 9.8.1	1.4 to 1.6		1.0	11.9	
			1.65 to 1.95		1.0	9.3	
			2.3 to 2.7		1.0	6.3	
			3.0 to 3.6		1.0	5.7	
		R <sub>L</sub> = 100 kΩ See Fig. 9.7.1, 9.8.2, Table 9.8.1	0.9	30	_	_	ns
		R <sub>L</sub> = 5 kΩ	1.1 to 1.3		1.0	63.7	
		See Fig. 9.7.1, 9.8.2, Table 9.8.1	1.4 to 1.6		1.0	16.5	
			1.65 to 1.95		1.0	13.7	
			2.3 to 2.7		1.0	8.8	
			3.0 to 3.6		1.0	7.2	
Output disable time	t <sub>PLZ</sub>	R <sub>L</sub> = 100 kΩ See Fig. 9.7.1, 9.8.2, Table 9.8.1	0.9	10	_	—	ns
		R <sub>L</sub> = 5 kΩ	1.1 to 1.3		1.0	26.7	
		See Fig. 9.7.1, 9.8.2, Table 9.8.1	1.4 to 1.6		1.0	11.7	
			1.65 to 1.95		1.0	10.8	
			2.3 to 2.7		1.0	9.5	
			3.0 to 3.6		1.0	11.3	
		R <sub>L</sub> = 100 kΩ See Fig. 9.7.1, 9.8.2, Table 9.8.1	0.9	15	—	—	ns
		R <sub>L</sub> = 5 kΩ	1.1 to 1.3		1.0	30.6	
		See Fig. 9.7.1, 9.8.2, Table 9.8.1	1.4 to 1.6		1.0	12.3	
			1.65 to 1.95		1.0	12.1	
			2.3 to 2.7		1.0	14.4	
			3.0 to 3.6		1.0	15.7	
		R <sub>L</sub> = 100 kΩ See Fig. 9.7.1, 9.8.2, Table 9.8.1	0.9	30	_		ns
		$R_L = 5 k\Omega$	1.1 to 1.3		1.0	39.3	
		See Fig. 9.7.1, 9.8.2, Table 9.8.1	1.4 to 1.6		1.0	16.1	
			1.65 to 1.95		1.0	18.0	
			2.3 to 2.7	1	1.0	13.2	
			3.0 to 3.6		1.0	17.8	

### 9.7. AC Test Circuit

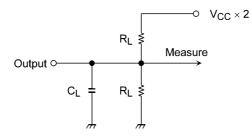


Fig. 9.7.1 AC Test Circuit

### 9.8. AC Waveform

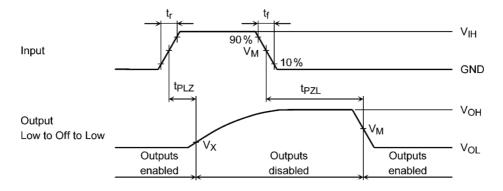


Fig. 9.8.1 t<sub>PLZ</sub>, t<sub>PZL</sub>

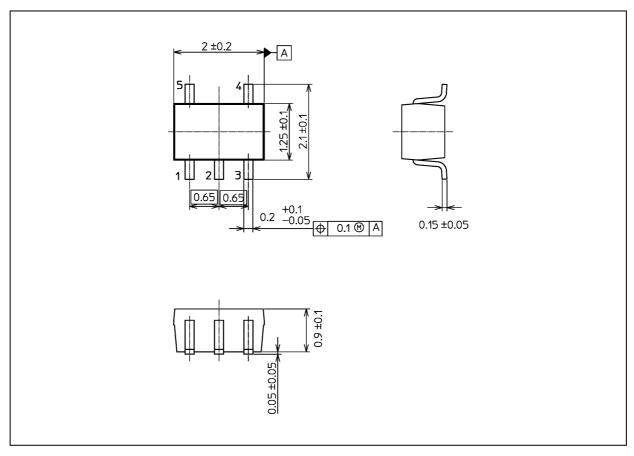
Table 9.8.1	AC Waveform Symbols
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	Symbol	V <sub>CC</sub> = 3.3 ± 0.3 V	V <sub>CC</sub> = 2.5 ± 0.2 V	V <sub>CC</sub> = 1.8 ± 0.15 V	V <sub>CC</sub> = 1.5 ± 0.1 V	V <sub>CC</sub> = 1.2 ± 0.1 V	V <sub>CC</sub> = 0.9 V
Input	V <sub>IH</sub>	V <sub>CC</sub>	V <sub>CC</sub>	V <sub>CC</sub>	V <sub>CC</sub>	V <sub>CC</sub>	V <sub>CC</sub>
	V <sub>M</sub>	V <sub>CC</sub> /2	V <sub>CC</sub> /2	V <sub>CC</sub> /2	V <sub>CC</sub> /2	V <sub>CC</sub> /2	V <sub>CC</sub> /2
Output	V <sub>M</sub>	V <sub>CC</sub> /2	V <sub>CC</sub> /2	V <sub>CC</sub> /2	V <sub>CC</sub> /2	V <sub>CC</sub> /2	V <sub>CC</sub> /2
	V <sub>X</sub>	V <sub>OL</sub> + 0.3 V	V <sub>OL</sub> + 0.15 V	V <sub>OL</sub> + 0.15 V	V <sub>OL</sub> + 0.1 V	V <sub>OL</sub> + 0.1 V	V <sub>OL</sub> + 0.1 V

### 7UL1G07FU

### Package Dimensions

Unit: mm



#### Weight: 6.2 mg (typ.)

	Package Name(s)
Nickname: USV	

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